

74AHCV245A

Octal bus transceiver; 3-state

Rev. 2 — 8 November 2016

Product data sheet

1. General description

The 74AHCV245A is an 8-bit transceiver with 3-state outputs and Schmitt trigger inputs. The device features an output enable ($\overline{OE}$) and send/receive (DIR) for direction control. A HIGH on $\overline{OE}$ causes the outputs to assume a high-impedance OFF-state.

Inputs are overvoltage tolerant. This feature allows the use of these devices as translators in mixed voltage environments.

The data (A_n , B_n) and control ($\overline{OE}$ and DIR) inputs include Schmitt trigger inputs. These inputs can transform slowly changing input signals into sharply defined, jitter-free output signals.

This device is ideal for driving bus lines or buffer memory address registers. It features inputs and outputs on opposite sides of the package to facilitate printed circuit board layout.

This device is fully specified for partial Power-down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2. Features and benefits

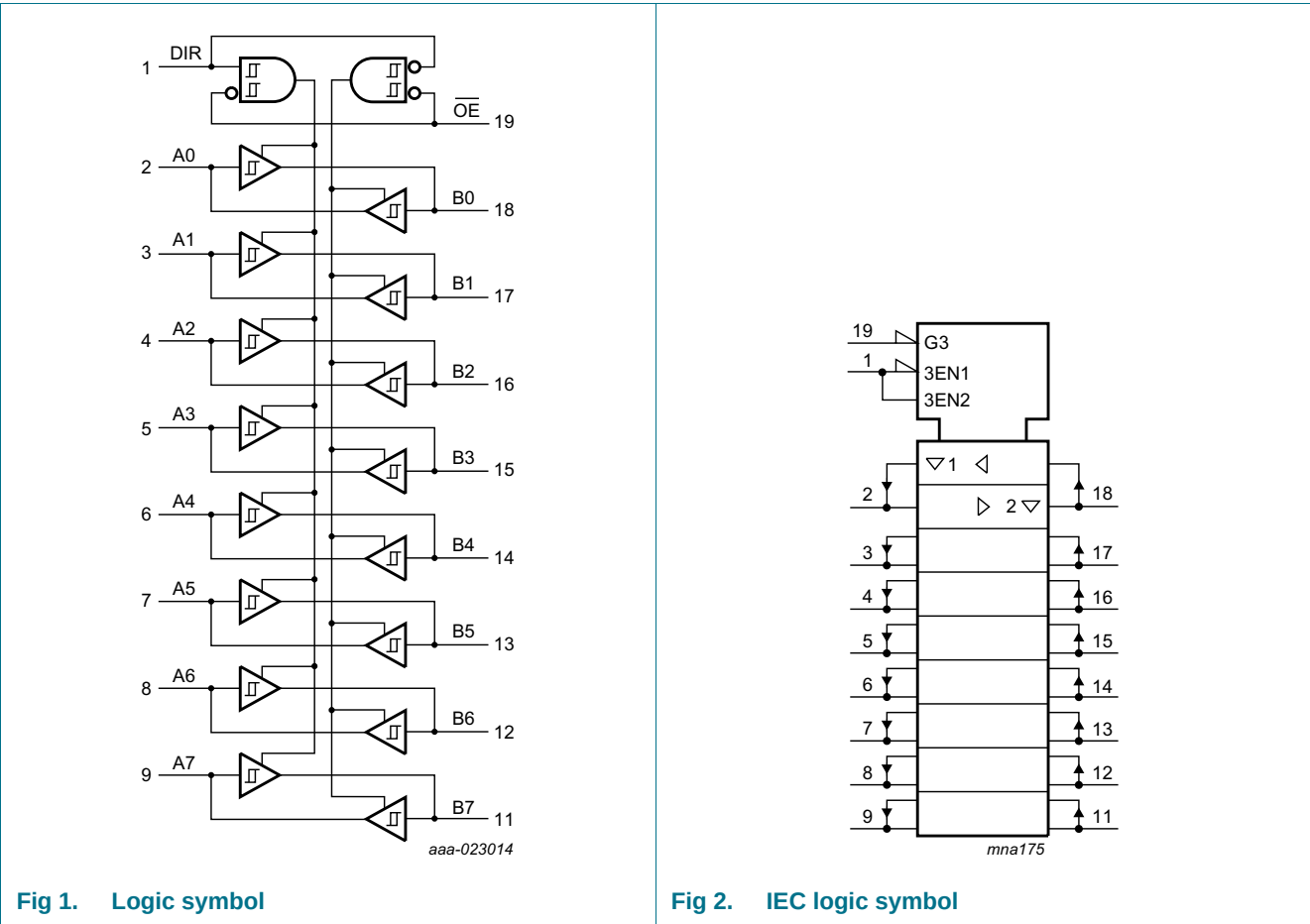
- Wide supply voltage range from 1.8 V to 5.5 V
- Typical t_{pd} of 3.2 ns at 5 V
- Typical $V_{OL(p)} < 0.8$ V at $V_{CC} = 3.3$ V, $T_{amb} = 25$ °C
- Typical $V_{OH(v)} > 2.3$ V at $V_{CC} = 3.3$ V, $T_{amb} = 25$ °C
- Supports mixed-mode voltage operation on all ports
- I_{OFF} circuitry provides partial Power-down mode operation
- Latch-up performance exceeds 250 mA per JESD 78 Class II
- ESD protection:
 - ◆ HBM ANSI/ESDA/JEDEC JS-001 Class 2 exceeds 3 kV
 - ◆ MM JESD22-A115-A exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 2 kV
- Specified from -40 °C to $+85$ °C and from -40 °C to $+125$ °C

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74AHCV245APW	−40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1

4. Functional diagram



5. Pinning information

5.1 Pinning

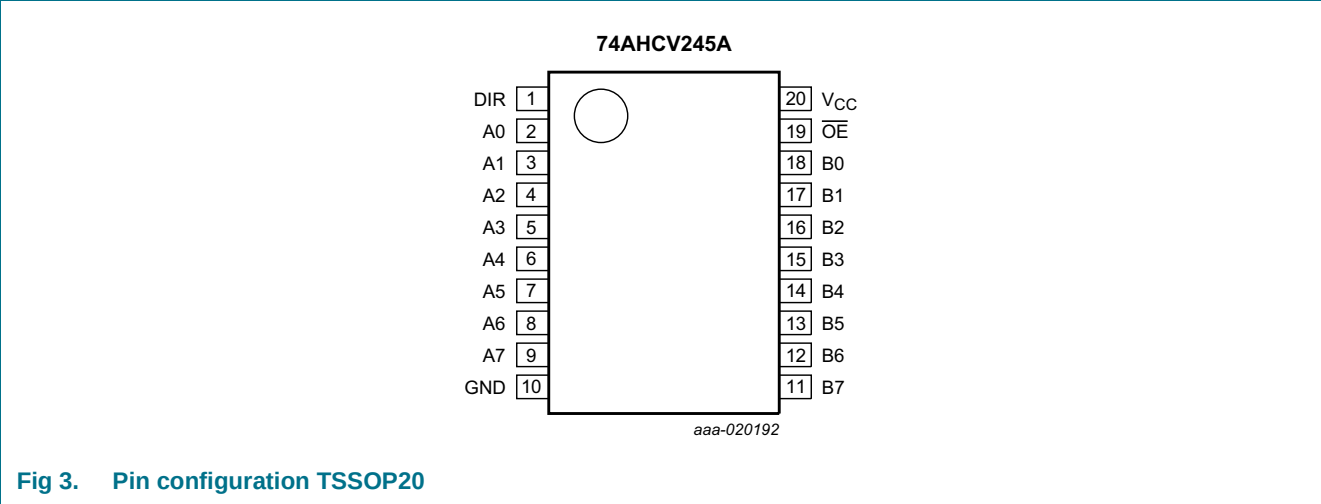


Fig 3. Pin configuration TSSOP20

5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
DIR	1	direction control
A0 to A7	2, 3, 4, 5, 6, 7, 8, 9	data input/output
GND	10	ground (0 V)
B0 to B7	18, 17, 16, 15, 14, 13, 12, 11	data input/output
$\overline{\text{OE}}$	19	output enable input (active LOW)
V _{CC}	20	supply voltage

6. Functional description

Table 3. Function table^[1]

Input		Input/output	
OE	DIR	An	Bn
L	L	A = B	input
L	H	input	B = A
H	X	Z	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		−0.5	+7.0	V
V _I	input voltage		−0.5	+7.0	V
V _O	output voltage	active mode	−0.5	V _{CC} + 0.5	V
		power-down or 3-state mode	−0.5	+7.0	V
I _{IK}	input clamping current	V _I < 0 V	−50	-	mA
I _{OK}	output clamping current	V _O < 0 V	−50	-	mA
I _O	output current	V _O = 0 V to V _{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		−100	-	mA
T _{stg}	storage temperature		−65	+150	°C
P _{tot}	total power dissipation	T _{amb} = −40 °C to +125 °C	-	500	mW

[1] If the input current ratings are observed, the minimum input voltage ratings may be exceeded.

[2] If the output current ratings are observed, the output voltage ratings may be exceeded.

[3] This value is limited to 7.0 V maximum.

[4] For TSSOP20 package: above 100 °C, the value of P_{tot} derates linearly with 10 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		1.8	5.5	V
V _I	input voltage		0	5.5	V
V _O	output voltage	active mode	0	V _{CC}	V
		power-down or 3-state mode	0	5.5	V
T _{amb}	ambient temperature		−40	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.3 V to 2.7 V	-	50	ms/V
		V _{CC} = 3.0 V to 3.6 V	-	20	ms/V
		V _{CC} = 4.5 V to 5.5 V	-	1	ms/V

9. Static characteristics

Table 6. Static characteristics

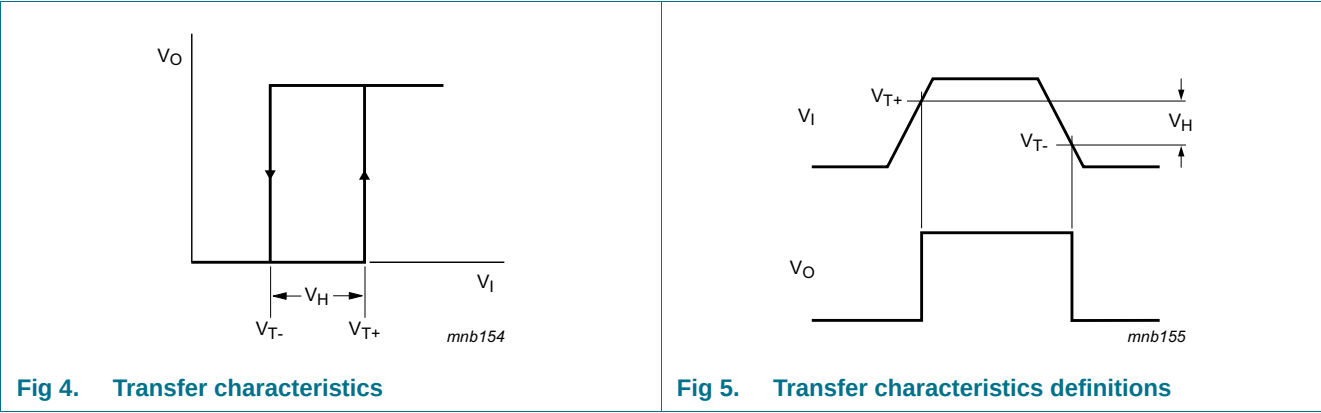
Voltages are referenced to GND (ground = 0 V).

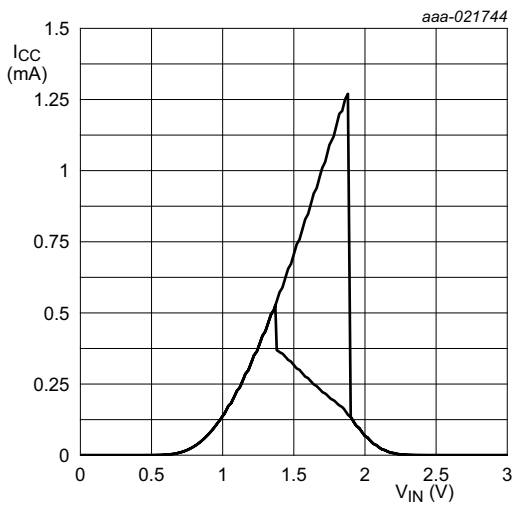
Symbol	Parameter	Conditions	25 °C			−40 °C to +85 °C		−40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
V _{T+}	positive-going threshold voltage	V _{CC} = 1.8 V	-	-	1.65	-	1.65	-	1.65	V
		V _{CC} = 2.3 V	-	-	1.85	-	1.85	-	1.85	V
		V _{CC} = 3.0 V	-	-	2.2	-	2.2	-	2.2	V
		V _{CC} = 4.5 V	-	-	3.15	-	3.15	-	3.15	V
		V _{CC} = 5.5 V	-	-	3.85	-	3.85	-	3.85	V
V _{T−}	negative-going threshold voltage	V _{CC} = 1.8 V	0.15	-	-	0.15	-	0.15	-	V
		V _{CC} = 2.3 V	0.45	-	-	0.45	-	0.45	-	V
		V _{CC} = 3.0 V	0.9	-	-	0.9	-	0.9	-	V
		V _{CC} = 4.5 V	1.35	-	-	1.35	-	1.35	-	V
		V _{CC} = 5.5 V	1.65	-	-	1.65	-	1.65	-	V
V _H	hysteresis voltage	V _{CC} = 1.8 V	0.15	-	1.05	0.15	1.05	0.15	1.05	V
		V _{CC} = 2.3 V	0.2	-	1.1	0.2	1.1	0.2	1.1	V
		V _{CC} = 3.0 V	0.3	-	1.2	0.3	1.2	0.3	1.2	V
		V _{CC} = 4.5 V	0.4	-	1.4	0.4	1.4	0.4	1.4	V
		V _{CC} = 5.5 V	0.5	-	1.6	0.5	1.6	0.5	1.6	V
V _{OH}	HIGH-level output voltage	V _I = V _{T+} or V _{T−}								V
		I _O = −50 μA; V _{CC} = 1.8 V	1.7	1.8	-	1.7	-	1.7	-	V
		I _O = −50 μA; V _{CC} = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V
		I _O = −50 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = −8 mA; V _{CC} = 3.0 V	2.58	-	-	2.48	-	2.48	-	V
		I _O = −16 mA; V _{CC} = 4.5 V	3.94	-	-	3.80	-	3.80	-	V

Table 6. Static characteristics ...continued
Voltages are referenced to GND (ground = 0 V).

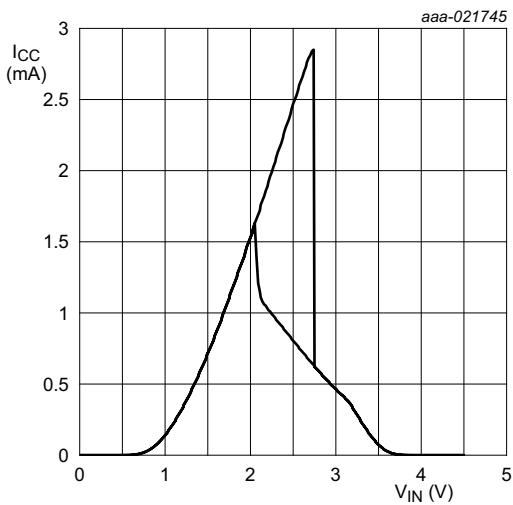
Symbol	Parameter	Conditions	25 °C			−40 °C to +85 °C		−40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
V _{OL}	LOW-level output voltage	V _I = V _{T+} or V _{T−}								
		I _O = 50 µA; V _{CC} = 1.8 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 50 µA; V _{CC} = 3.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 50 µA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 8 mA; V _{CC} = 3.0 V	-	-	0.36	-	0.44	-	0.44	V
		I _O = 16 mA; V _{CC} = 4.5 V	-	-	0.44	-	0.55	-	0.55	V
I _{OZ}	OFF-state output current	V _{CC} = 5.5 V; V _I = V _{IH} or V _{IL} ; V _O = GND to 5.5 V	-	-	±0.25	-	±2.5	-	±2.5	µA
I _{OFF}	power-off leakage current	V _I or V _O = GND to 5.5 V; V _{CC} = 0 V	-	-	0.5	-	5	-	5	µA
I _I	input leakage current	V _I = V _{CC} or GND; V _{CC} = 0 V to 5.5 V	-	-	±0.1	-	±1	-	±1	µA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V	-	-	2	-	20	-	20	µA

9.1 Transfer characteristics waveforms

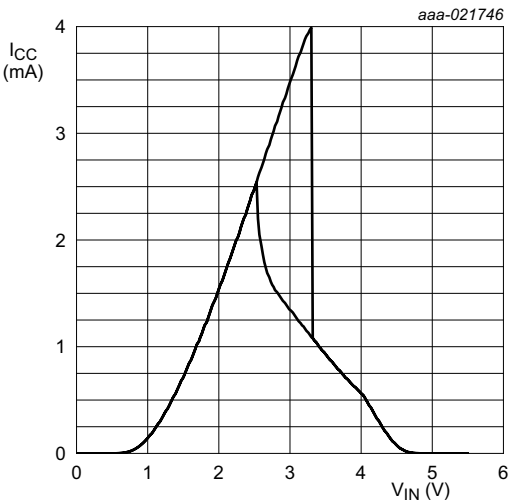




a. $V_{CC} = 3.0\text{ V}$



b. $V_{CC} = 4.5\text{ V}$



c. $V_{CC} = 5.5\text{ V}$

Fig 6. Typical transfer characteristics

10. Dynamic characteristics

Table 7. Dynamic characteristics
GND = 0 V. For test circuit, see Figure 9.

Symbol	Parameter	Conditions	25 °C			−40 °C to +85 °C		−40 °C to +125 °C		Unit
			Min	Typ ^[1]	Max	Min	Max	Min	Max	
t _{pd}	propagation delay	An to Bn or Bn to An; see Figure 7								
		V _{CC} = 2.3 V to 2.7 V								
		C _L = 15 pF	-	5.3	13	1	15	1	16.3	ns
		C _L = 50 pF	-	7.3	15.9	1	18	1	19.4	ns
		V _{CC} = 3.0 V to 3.6 V								
		C _L = 15 pF	-	4.1	8.4	1	10	1	10.9	ns
		C _L = 50 pF	-	5.7	11.9	1	13.5	1	14.6	ns
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	3.2	5.5	1	6.5	1	7	ns
		C _L = 50 pF	-	4.5	7.5	1	8.5	1	9.3	ns
t _{en}	enable time	$\overline{\text{OE}}$ to An or $\overline{\text{OE}}$ to Bn; see Figure 8								
		V _{CC} = 2.3 V to 2.7 V								
		C _L = 15 pF	-	6.5	19.9	1	22	1	23	ns
		C _L = 50 pF	-	8.6	22.7	1	26	1	27	ns
		V _{CC} = 3.0 V to 3.6 V								
		C _L = 15 pF	-	4.9	13.2	1	15.5	1	16	ns
		C _L = 50 pF	-	6.6	16.7	1	19	1	20	ns
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	3.7	8.5	1	10	1	10.5	ns
		C _L = 50 pF	-	5.1	10.6	1	12	1	12.5	ns
t _{dis}	disable time	$\overline{\text{OE}}$ to An or $\overline{\text{OE}}$ to Bn; see Figure 8								
		V _{CC} = 2.3 V to 2.7 V								
		C _L = 15 pF	-	7	15.1	1	16.7	1	17.8	ns
		C _L = 50 pF	-	11.6	23.1	1	25	1	26	ns
		V _{CC} = 3.0 V to 3.6 V								
		C _L = 15 pF	-	5.7	10.5	1	12.3	1	13.2	ns
		C _L = 50 pF	-	9.1	15.8	1	18	1	19	ns
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	4.5	6.9	1	8	1	8.5	ns
		C _L = 50 pF	-	6.7	9.7	1	11	1	11.5	ns
t _{sk(o)}	output skew time	C _L = 50 pF								
		V _{CC} = 2.3 V to 2.7 V	-	-	2	-	2	-	2	ns
		V _{CC} = 3.0 V to 3.6 V	-	-	1.5	-	1.5	-	1.5	ns
		V _{CC} = 4.5 V to 5.5 V	-	-	1	-	1	-	1	ns

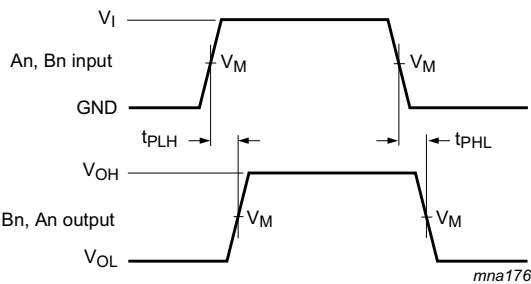
Table 7. Dynamic characteristics ...continuedGND = 0 V. For test circuit, see [Figure 9](#).

Symbol	Parameter	Conditions	25 °C			–40 °C to +85 °C		–40 °C to +125 °C		Unit
			Min	Typ ^[1]	Max	Min	Max	Min	Max	
C _I	input capacitance	V _I = V _{CC} or GND; V _{CC} = 3.3 V	-	2	6	-	6	-	6	pF
C _{I/O}	input/output capacitance	V _O = V _{CC} or GND; V _{CC} = 3.3 V	-	5.5	-	-	-	-	-	pF
C _{PD}	power dissipation capacitance	per buffer; ^[3] C _L = 0 pF; f = 10 MHz; V _{CC} = 5 V; V _I = GND to V _{CC}	-	13.8	-	-	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 2.5 V, 3.3 V, and 5 V respectively, unless otherwise specified.[2] t_{pd} is the same as t_{PLH} and t_{PHL}.t_{en} is the same as t_{pZL} and t_{pZH}.t_{dis} is the same as t_{pLZ} and t_{pHZ}.[3] C_{PD} is used to determine the dynamic power dissipation P_D (μW). $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:f_i = input frequency in MHz;f_o = output frequency in MHz;C_L = output load capacitance in pF;V_{CC} = supply voltage in Volts.**Table 8. Noise characteristics**GND = 0 V. For test circuit, see [Figure 9](#).

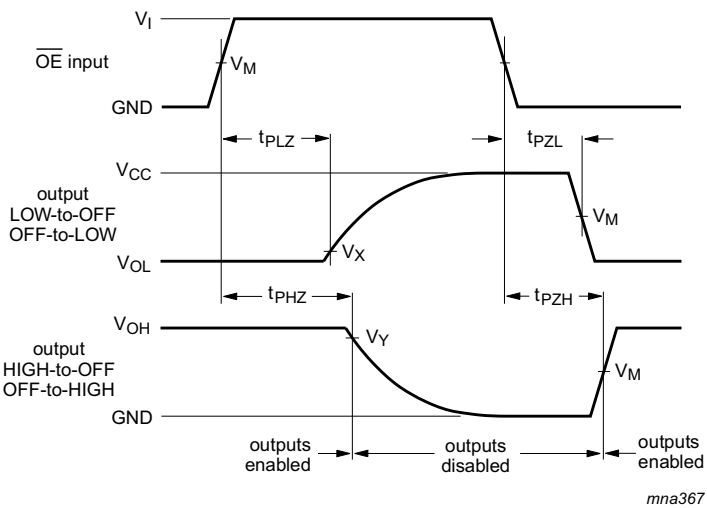
Symbol	Parameter	Conditions	T _{amb} = 25 °C			Unit
			Min	Typ	Max	
V _{CC} = 3.3 V; C _L = 50 pF						
V _{OL(p)}	LOW-level output voltage (peak)		-	0.3	0.8	V
V _{OL(v)}	LOW-level output voltage (valley)		−0.8	−0.2	-	V
V _{OH(v)}	HIGH-level output voltage (valley)		-	2.9	-	V
V _{IH(AC)}	AC HIGH-level input voltage	dynamic	2.31	-	-	V
V _{IL(AC)}	AC LOW-level input voltage	dynamic	-	-	0.99	V
V _{CC} = 5.0 V; C _L = 50 pF						
V _{OL(p)}	LOW-level output voltage (peak)		-	0.6	1.5	V
V _{OL(v)}	LOW-level output voltage (valley)		−1.5	−0.6	-	V
V _{OH(v)}	HIGH-level output voltage (valley)		-	4.0	-	V
V _{IH(AC)}	AC HIGH-level input voltage	dynamic	3.5	-	-	V
V _{IL(AC)}	AC LOW-level input voltage	dynamic	-	-	1.5	V

11. Waveforms



Measurement points are given in [Table 9](#).
 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig 7. Propagation delay input (An, Bn) to output (Bn, An)



Measurement points are given in [Table 9](#).
 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig 8. Enable and disable times

Table 9. Measurement points

Input	Output		
V_M	V_M	V_X	V_Y
$0.5V_{CC}$	$0.5V_{CC}$	$V_{OL} + 0.3\text{ V}$	$V_{OH} - 0.3\text{ V}$

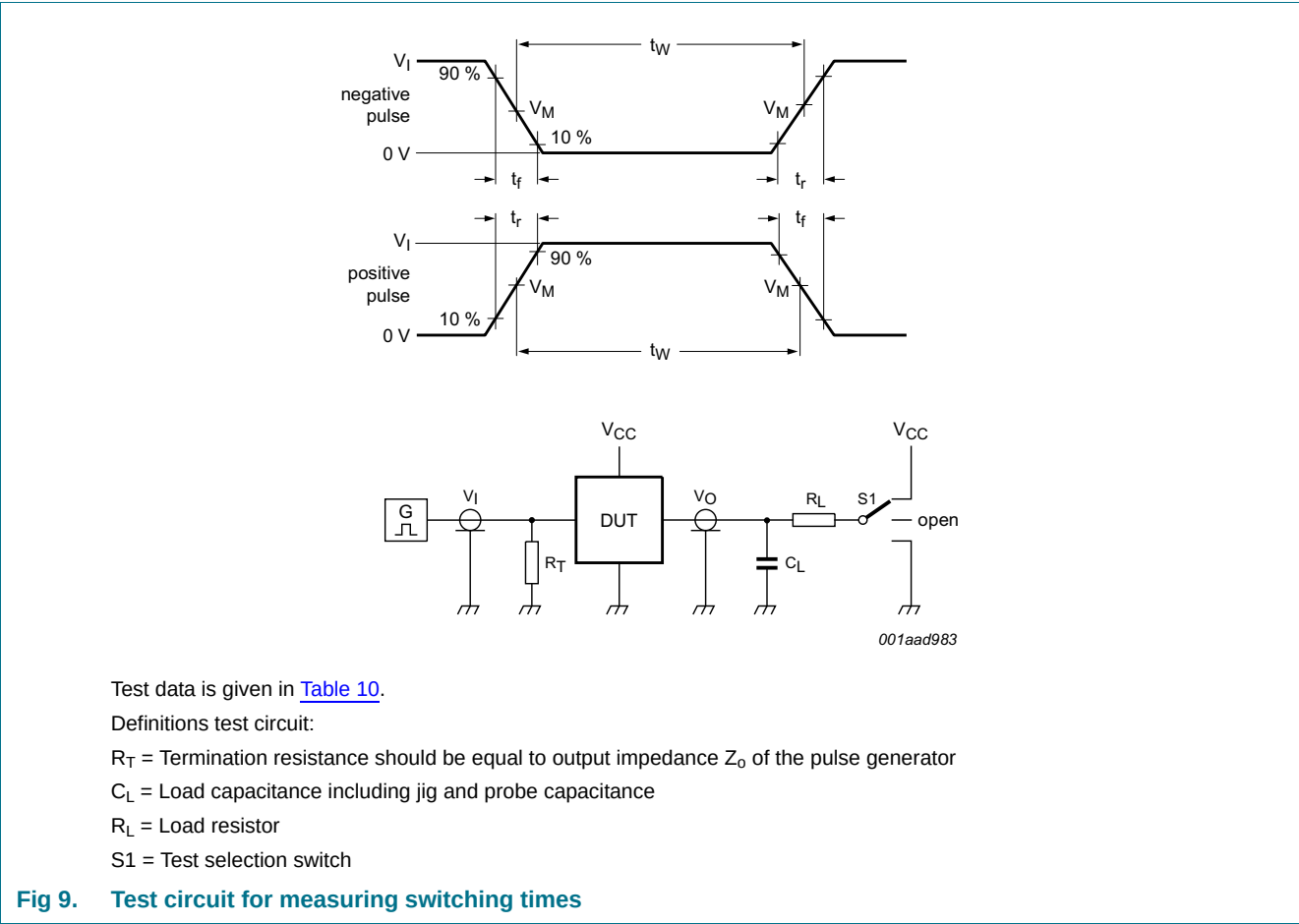


Table 10. Test data

Input		Load		S1 position		
V_I	t_r, t_f	C_L	R_L	t_{PHL}, t_{PLH}	t_{PZH}, t_{PHZ}	t_{PZL}, t_{PLZ}
GND to V_{CC}	3.0 ns	15 pF, 50 pF	1 k Ω	open	GND	V_{CC}

12. Package outline

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1

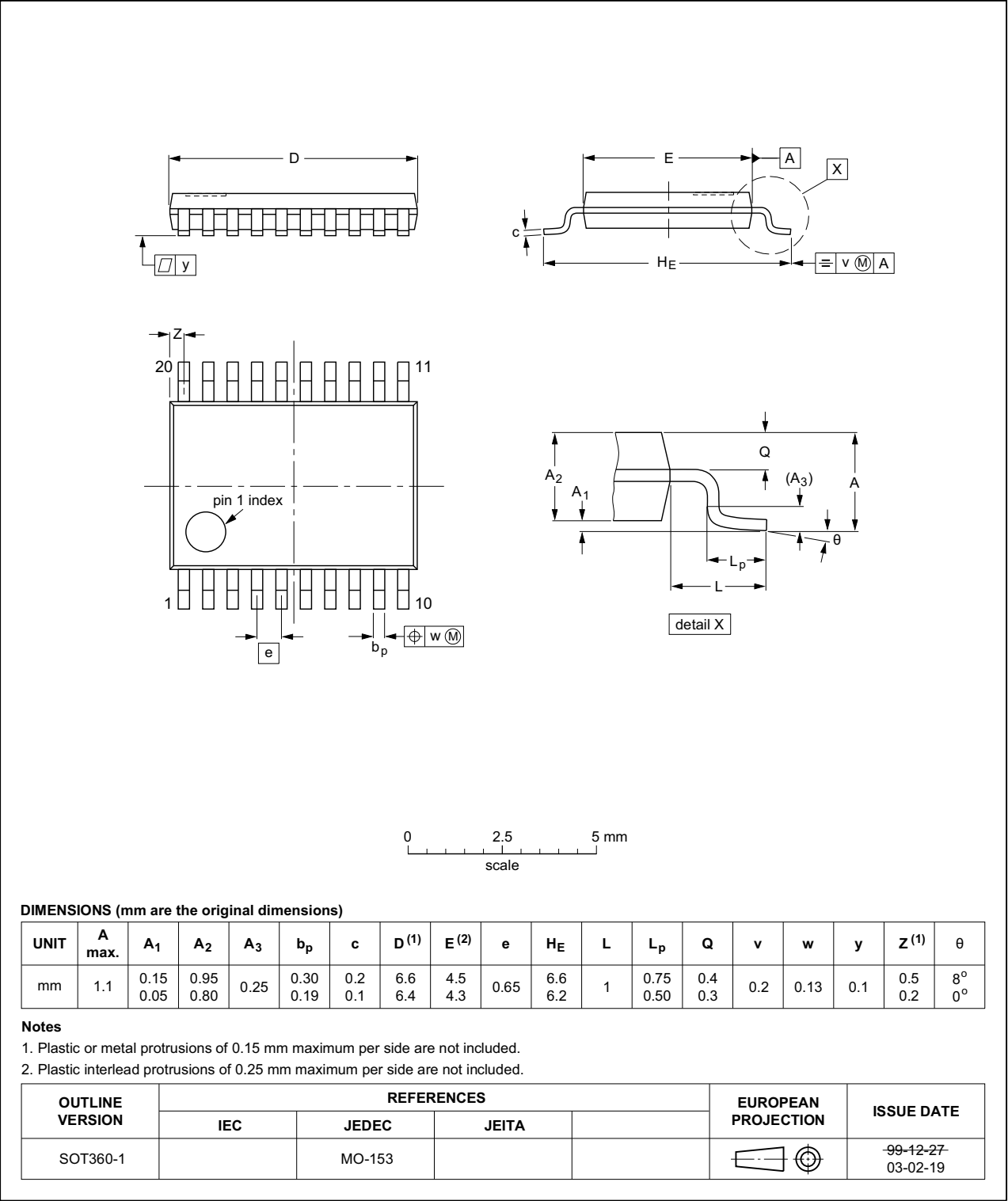


Fig 10. Package outline SOT360-1 (TSSOP20)

13. Abbreviations

Table 11. Abbreviations

Acronym	Description
CDM	Charge Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AHCV245A v.2	20161108	Product data sheet	-	74AHCV245A v.1
Modifications:	• Type number 74AHCV245ABQ removed.			
74AHCV245A v.1	20160610	Product data sheet	-	-

15. Legal information

15.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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